

## General Purpose Schottky Barrier Diode

### General Description

These Schottky barrier diodes are designed for high-speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.



**SOT-23**

### Features and Benefits

Low forward drop voltage and low leakage current

Very low switching time

### Applications

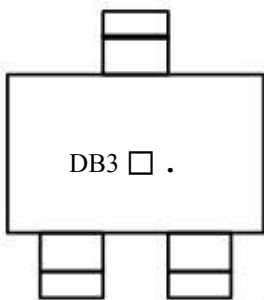
General purpose and high speed switching

Protection circuit and voltage clamping

### Ordering Information

Part Number	Marking Code	Package	Packaging
KDB310WM	DB3 □ .	SOT-23	Tape & Reel

### Marking Information

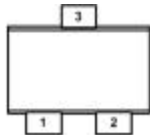
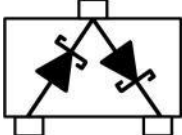


**DB3 = Specific Device Code**

**□ = Year & Week Code Marking**

**• = Da Lian**

### Pinning Information

Pin	Description	Simplified Outline	Graphic Symbol
1	Anode (Diode 1)		
2	Cathode (Diode 2)		
3	Cathode (Diode 1) Anode (Diode 1)		

## Absolute Maximum Ratings (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Peak reverse voltage	V <sub>RM</sub>	40	V
DC reverse voltage	V <sub>R</sub>	30	V
Repetitive peak forward current	I <sub>FRM</sub>	0.5	A
Forward current	I <sub>F</sub>	0.2	A
Non-repetitive peak forward surge current(t=10ms)	I <sub>FSM</sub>	2	A
Power dissipation <sup>1)</sup>	P <sub>D</sub>	150	mW

<sup>1)</sup> Device mounted on FR-4 board with recommended pad layout.

## Thermal Characteristics (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Thermal resistance, junction to ambient <sup>1)</sup>	R <sub>th(j-a)</sub>	833	°C/W
Operating junction temperature	T <sub>j</sub>	150	°C
Storage temperature range	T <sub>stg</sub>	-55~150	°C

<sup>1)</sup> Device mounted on FR-4 board with recommended pad layout.

## Electrical Characteristics (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit.
Forward voltage <sup>2)</sup>	V <sub>F(1)</sub>	I <sub>F</sub> =10mA	-	-	0.4	V
	V <sub>F(2)</sub>	I <sub>F</sub> =30mA	-	-	0.5	V
Reverse leakage current <sup>3)</sup>	I <sub>R</sub>	V <sub>R</sub> =30V	-	-	1	μA
Total capacitance	C <sub>T</sub>	V <sub>R</sub> =1V, f=1MHz	-	-	10	pF
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = I <sub>R</sub> =10mA, I <sub>R(REC)</sub> = 1mA	-	-	5	ns

<sup>2)</sup> Pulse test: t<sub>P</sub>≤380μs, Duty cycle≤2%

<sup>3)</sup> Pulse test: t<sub>P</sub>≤5 ms, Duty cycle≤2%

## Rating and Characteristic Curves

Fig. 1) Typical Forward Characteristics

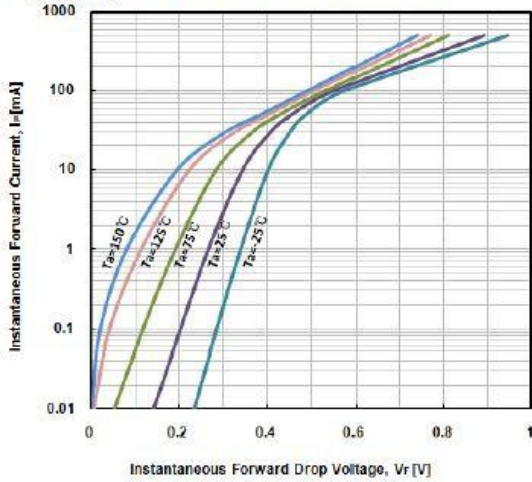


Fig. 2) Typical Reverse Characteristics

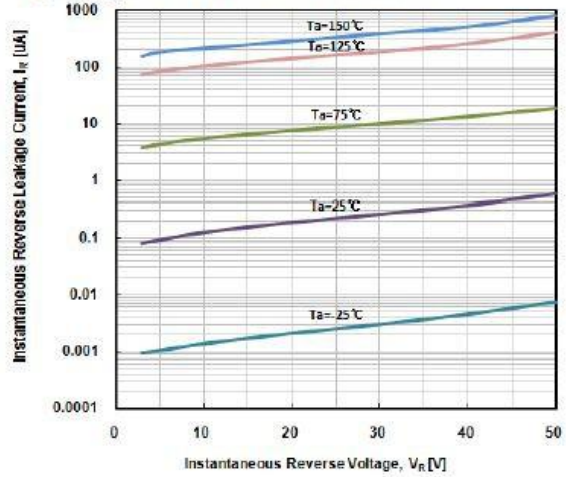


Fig. 3) Typical Total Capacitance Characteristics

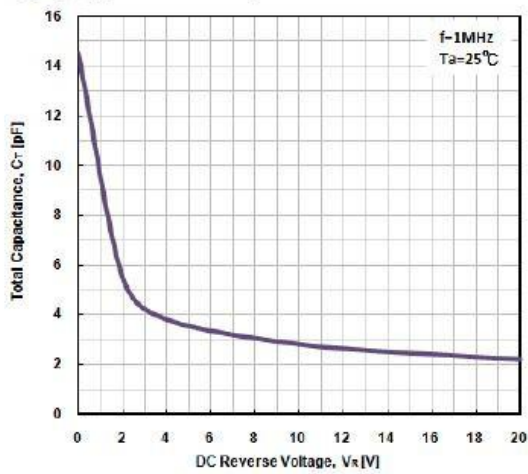
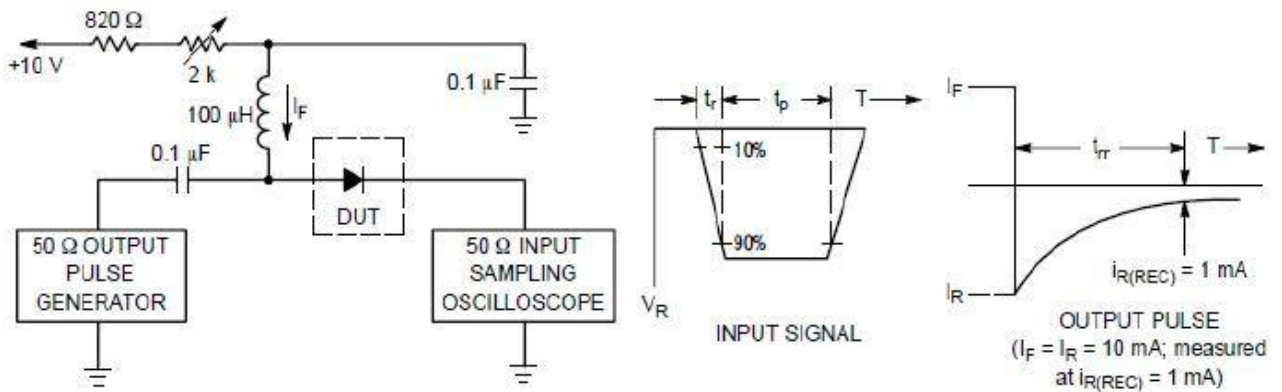
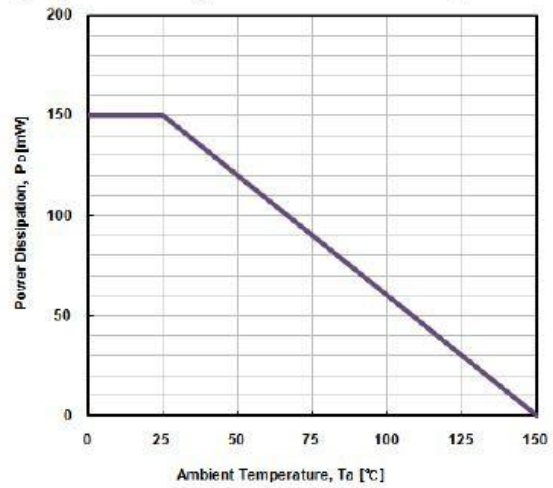
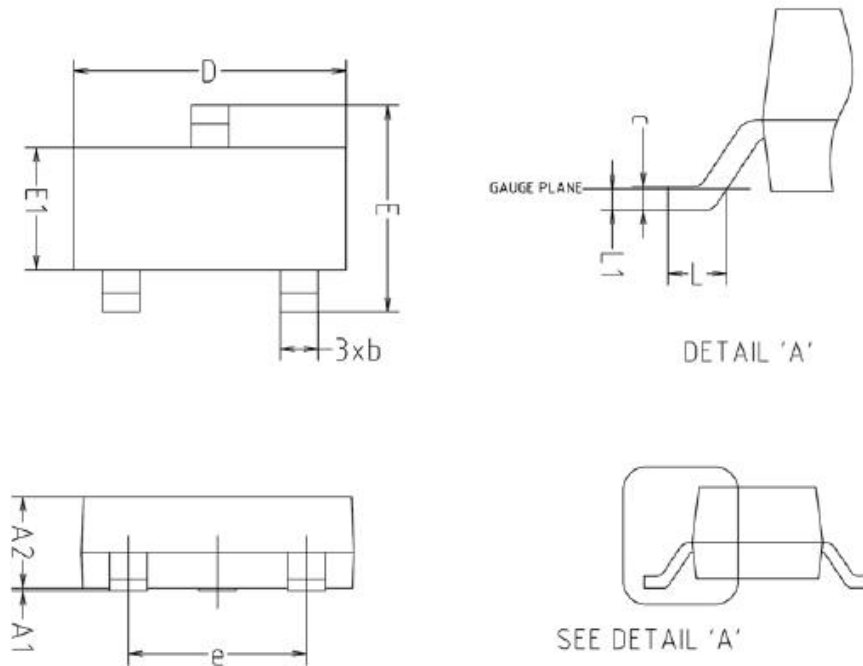


Fig. 4) Power dissipation vs. Ambient temperature

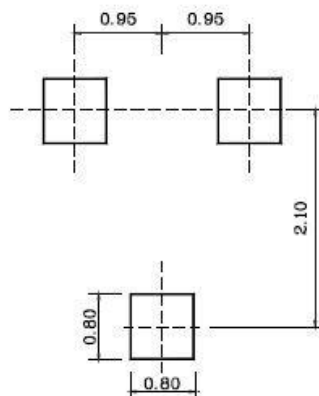


## Package Outline Dimensions



SYMBOL	MILLIMETERS			NOTE
	MINIMUM	NOMINAL	MAXIMUM	
A1	0.00	-	0.10	
A2	0.82	-	1.02	
b	0.39	0.42	0.45	
c	0.09	0.12	0.15	
D	2.80	2.90	3.00	
E	2.20	2.40	2.60	
E1	1.20	1.30	1.40	
e	1.90BSC			
L	0.20	-	-	
L1	0.12BSC			

※ Recommend PCB solder land (Unit : mm)



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